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TO the nonviable Commissioner of Faterits and Trademarks. F	and documents or copy thereof.	
1 Name of conveying party(ies): Tien-Chen Hu, Jih-Churng Twu, Ying-Ho Chen and Tsu Shih 3 Nature of conveyance: ■ Assignment □ Merger □ Security Agreement □ Change of Name □ Other: Execution Date: July 9, 1999 4 Application number(s) or patent number(s):	2 Name and address of receiving party(ies): Taiwan Semiconductor Manufacturing Company Ltd. No. 121 Park Avenue 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C. Additional name(s) & address(es) attached Tes & No	
If this document is being filed together with a new application, the execution date of the application is: July 9, 1999		
A. Patent Application No(s).	B. Patent No(s)	
 Additional numbers attached? □ Yes ◙ No		
5 Name and address of party to whom correspondence concerning document should be mailed:	6 Total number of applications and patents involved:	
RANDY W. TUNG Tung & Associates 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302	7 Total fee (37 CFR 3.41) \$40.00 □ Enclosed □ Authorized to be charged to deposit account	
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Washington, D.C. 20231

PATENT REEL: 010157 FRAME: 0383

ASSIGNMENT

WHEREAS, we, <u>TIEN-CHEN HU, JIH-CHURNG TWU, YING-HO CHEN AND TSU SHIH</u> have invented certain improvements in APPARATUS AND METHOD FOR CHEMICAL MECHANICAL POLISHING A SEMICONDUCTOR WAFER for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, <u>TIEN-CHEN HU, JIH-CHURNG TWU, YING-HO CHEN AND TSU SHIH</u>, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the <u>Grib</u> day of <u>100</u>, 1999, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue of any such patent,

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and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

TIEN-CHEN HU

JIH-CHURNG

Ying-Ho Chen

TSU SHIH

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302